

16-BIT REGISTERED TRANSCEIVER WITH 3-STATE OUTPUTS

SCAS320F – NOVEMBER 1993 – REVISED JUNE 1998

- Member of the Texas Instruments **Widebus™** Family
- **EPIC™** (Enhanced-Performance Implanted CMOS) Submicron Process
- Typical V_{OLP} (Output Ground Bounce) < 0.8 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- Typical V_{OHV} (Output V_{OH} Undershoot) > 2 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V_{CC})
- Power Off Disables Outputs, Permitting Live Insertion
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model ($C = 200$ pF, $R = 0$)
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages

description

This 16-bit registered transceiver is designed for 1.65-V to 3.6-V V_{CC} operation.

The SN74LVCH16952A contains two sets of D-type flip-flops for temporary storage of data flowing in either direction. It can be used as two 8-bit transceivers or one 16-bit transceiver. Data on the A or B bus is stored in the registers on the low-to-high transition of the clock (CLKAB or CLKBA) input, provided that the clock-enable (CEAB or CEBA) input is low. Taking the output-enable (OEAB or OEBA) input low accesses the data on either port.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN74LVCH16952A is characterized for operation from -40°C to 85°C .

DGG OR DL PACKAGE
(TOP VIEW)

$\overline{1OEAB}$	1	56	$\overline{1OEBA}$
$1CLKAB$	2	55	$1CLKBA$
$\overline{1CEAB}$	3	54	$\overline{1CEBA}$
GND	4	53	GND
$1A1$	5	52	$1B1$
$1A2$	6	51	$1B2$
V_{CC}	7	50	V_{CC}
$1A3$	8	49	$1B3$
$1A4$	9	48	$1B4$
$1A5$	10	47	$1B5$
GND	11	46	GND
$1A6$	12	45	$1B6$
$1A7$	13	44	$1B7$
$1A8$	14	43	$1B8$
$2A1$	15	42	$2B1$
$2A2$	16	41	$2B2$
$2A3$	17	40	$2B3$
GND	18	39	GND
$2A4$	19	38	$2B4$
$2A5$	20	37	$2B5$
$2A6$	21	36	$2B6$
V_{CC}	22	35	V_{CC}
$2A7$	23	34	$2B7$
$2A8$	24	33	$2B8$
GND	25	32	GND
$\overline{2CEAB}$	26	31	$\overline{2CEBA}$
$2CLKAB$	27	30	$2CLKBA$
$\overline{2OEAB}$	28	29	$\overline{2OEBA}$

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FUNCTION TABLE†

INPUTS				OUTPUT
$\overline{\text{CEAB}}$	CLKAB	$\overline{\text{OEAB}}$	A	B
H	X	L	X	B_0^\ddagger
X	L	L	X	B_0^\ddagger
L	\uparrow	L	L	L
L	\uparrow	L	H	H
X	X	H	X	Z

† A-to-B data flow is shown; B-to-A data flow is similar, but uses $\overline{\text{CEBA}}$, CLKBA , and $\overline{\text{OEBA}}$.

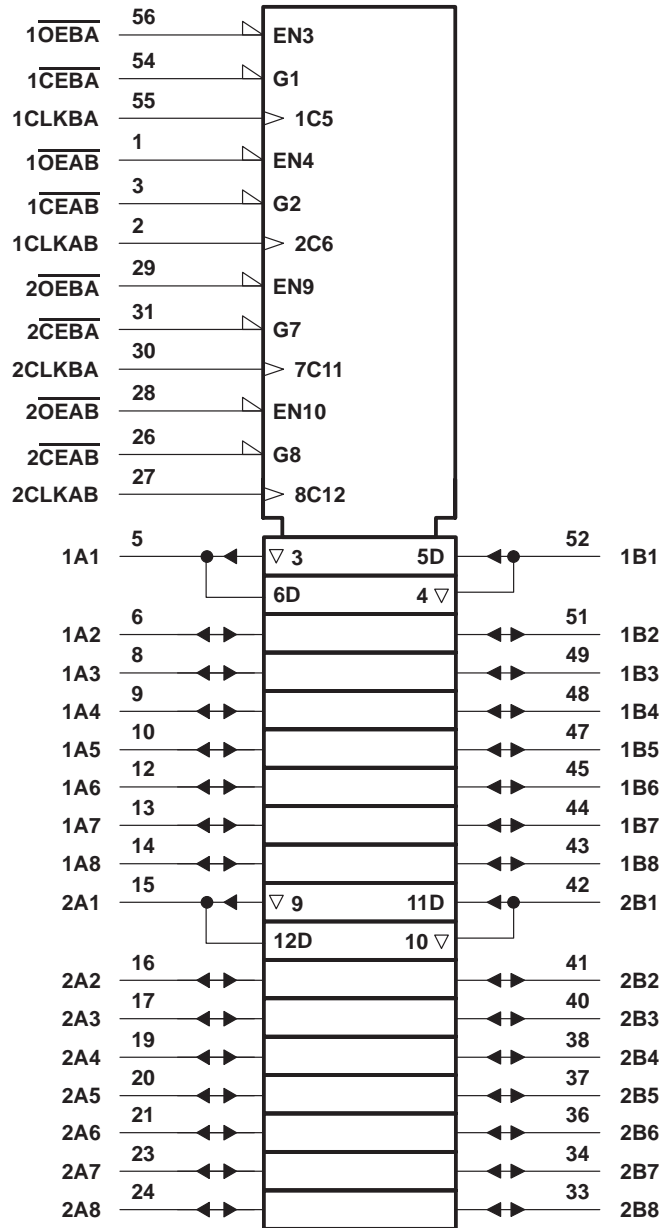
‡ Level of B before the indicated steady-state input conditions were established

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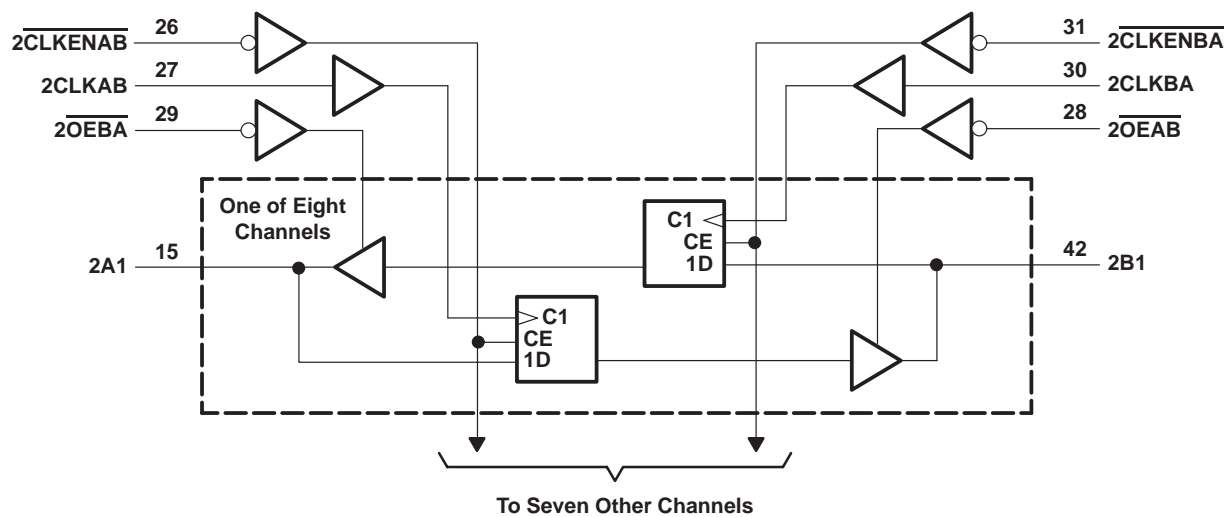
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logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	–0.5 V to 6.5 V
Input voltage range, V_I : (see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high-impedance or power-off state, V_O (see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high or low state, V_O (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	–50 mA
Output clamp current, I_{OK} ($V_O < 0$)	–50 mA
Continuous output current, I_O	±50 mA
Continuous current through V_{CC} or GND	±100 mA
Package thermal impedance, θ_{JA} (see Note 3): DGG package	81°C/W
DL package	74°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The value of V_{CC} is provided in the recommended operating conditions table.
3. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 4)

		MIN	MAX	UNIT
V_{CC} Supply voltage	Operating	1.65	3.6	V
	Data retention only	1.5		
V_{IH} High-level input voltage	$V_{CC} = 1.65$ V to 1.95 V	$0.65 \times V_{CC}$		V
	$V_{CC} = 2.3$ V to 2.7 V	1.7		
	$V_{CC} = 2.7$ V to 3.6 V	2		
V_{IL} Low-level input voltage	$V_{CC} = 1.65$ V to 1.95 V	$0.35 \times V_{CC}$		V
	$V_{CC} = 2.3$ V to 2.7 V	0.7		
	$V_{CC} = 2.7$ V to 3.6 V	0.8		
V_I Input voltage		0	5.5	V
V_O Output voltage	High or low state	0	V_{CC}	V
	3 state	0	5.5	
I_{OH} High-level output current	$V_{CC} = 1.65$ V		–4	mA
	$V_{CC} = 2.3$ V		–8	
	$V_{CC} = 2.7$ V		–12	
	$V_{CC} = 3$ V		–24	
I_{OL} Low-level output current	$V_{CC} = 1.65$ V		4	mA
	$V_{CC} = 2.3$ V		8	
	$V_{CC} = 2.7$ V		12	
	$V_{CC} = 3$ V		24	
$\Delta t/\Delta v$ Input transition rise or fall rate		0	10	ns/V
T_A Operating free-air temperature		–40	85	°C

NOTE 4: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		V _{CC}	MIN	TYP†	MAX	UNIT
V _{OH}		I _{OH} = −100 μA		1.65 V to 3.6 V	V _{CC} −0.2			V
		I _{OH} = −4 mA		1.65 V	1.2			
		I _{OH} = −8 mA		2.3 V	1.7			
		I _{OH} = −12 mA		2.7 V	2.2			
		I _{OH} = −24 mA		3 V	2.4			
		I _{OH} = −24 mA		3 V	2.2			
V _{OL}		I _{OL} = 100 μA		1.65 V to 3.6 V			0.2	V
		I _{OL} = 4 mA		1.65 V			0.45	
		I _{OL} = 8 mA		2.3 V			0.7	
		I _{OL} = 12 mA		2.7 V			0.4	
		I _{OL} = 24 mA		3 V			0.55	
I _I	Control inputs	V _I = 0 to 5.5 V		3.6 V			±5	μA
I _I (hold)	A or B ports	V _I = 0.58 V		1.65 V	‡			μA
		V _I = 1.07 V			‡			
		V _I = 0.7 V		2.3 V	45			
		V _I = 1.7 V			−45			
		V _I = 0.8 V		3 V	75			
		V _I = 2 V			−75			
		V _I = 0 to 3.6 V§		3.6 V	±500			
I _{off}		V _I or V _O = 5.5 V		0	±10		μA	
I _{OZ} ¶		V _O = 0 to 5.5 V		3.6 V	±10		μA	
I _{CC}		V _I = V _{CC} or GND	I _O = 0	3.6 V	20		μA	
		3.6 V ≤ V _I ≤ 5.5 V#			20			
ΔI _{CC}		One input at V _{CC} − 0.6 V, Other inputs at V _{CC} or GND		2.7 V to 3.6 V	500		μA	
C _i	Control inputs	V _I = V _{CC} or GND		3.3 V	5		pF	
C _{iO}	A or B ports	V _O = V _{CC} or GND		3.3 V	8.5		pF	

† All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

‡ This information was not available at the time of publication.

§ This is the bus-hold maximum dynamic current required to switch the input from one state to another.

¶ For I/O ports, the parameter I_{OZ} includes the input leakage current, but not I_I(hold).

This applies in the disabled state only.

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timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

			$V_{CC} = 1.8\text{ V}$ $\pm 0.15\text{ V}$		$V_{CC} = 2.5\text{ V}$ $\pm 0.2\text{ V}$		$V_{CC} = 2.7\text{ V}$		$V_{CC} = 3.3\text{ V}$ $\pm 0.3\text{ V}$		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f _{clock}	Clock frequency		†		†		150		150		MHz
t _w	Pulse duration, CLK high or low		†		†		3.3		3.3		ns
t _{su}	Setup time	Data before CLK↑	†		†		3.4		2.8		ns
		$\overline{\text{CE}}$ before CLK↑	†		†		1.8		1.4		
t _h	Hold time	Data after CLK↑	†		†		0.5		0.5		ns
		$\overline{\text{CE}}$ after CLK↑	†		†		1.1		1.9		

† This information was not available at the time of publication.

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 1.8\text{ V}$ $\pm 0.15\text{ V}$		$V_{CC} = 2.5\text{ V}$ $\pm 0.2\text{ V}$		$V_{CC} = 2.7\text{ V}$		$V_{CC} = 3.3\text{ V}$ $\pm 0.3\text{ V}$		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f_{max}				†		†		150		150	MHz
t_{pd}	CLKAB or CLKBA	B or A	†	†	†	†		7.6	1.6	6.6	ns
t_{en}	$\overline{\text{OE}}$	A or B	†	†	†	†		8	1.1	6.6	ns
t_{dis}	$\overline{\text{OE}}$	A or B	†	†	†	†		7.1	1.9	6.7	ns
$t_{\text{sk(o)}}^{\ddagger}$										1	ns

† This information was not available at the time of publication.

‡ Skew between any two outputs of the same package switching in the same direction

operating characteristics, $T_A = 25^\circ\text{C}$

PARAMETER			TEST CONDITIONS	$V_{CC} = 1.8\text{ V}$ $\pm 0.15\text{ V}$	$V_{CC} = 2.5\text{ V}$ $\pm 0.2\text{ V}$	$V_{CC} = 3.3\text{ V}$ $\pm 0.3\text{ V}$	UNIT
				TYP	TYP	TYP	
C_{pd}	Power dissipation capacitance per transceiver	Outputs enabled	$f = 10\text{ MHz}$	†	†	87	pF
		Outputs disabled		†	†	43	

† This information was not available at the time of publication.

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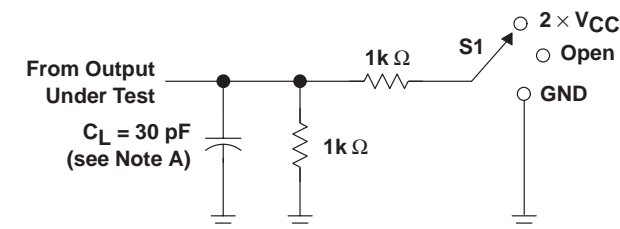
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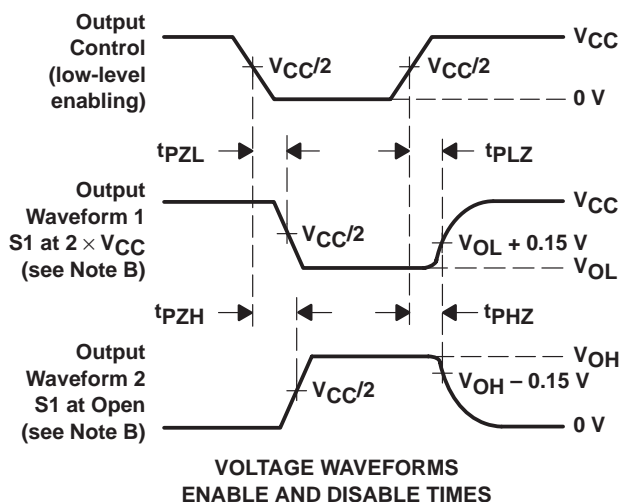
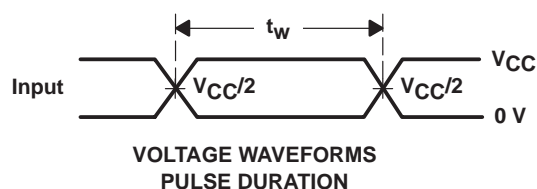
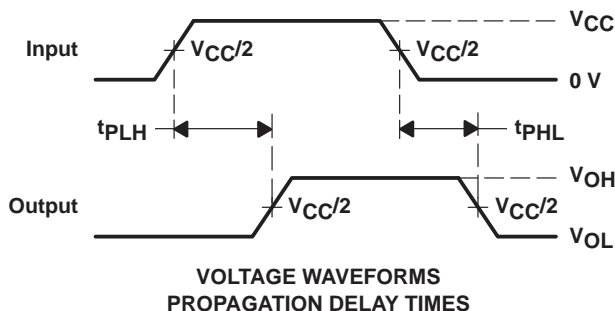
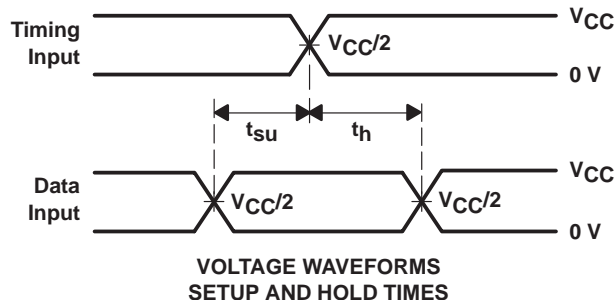
PARAMETER MEASUREMENT INFORMATION

$$V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$$



LOAD CIRCUIT

TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	$2 \times V_{CC}$
t_{PHZ}/t_{PZH}	Open



- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2 \text{ ns}$, $t_f \leq 2 \text{ ns}$.
 - The outputs are measured one at a time with one transition per measurement.
 - t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - t_{PZL} and t_{PZH} are the same as t_{en} .
 - t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms

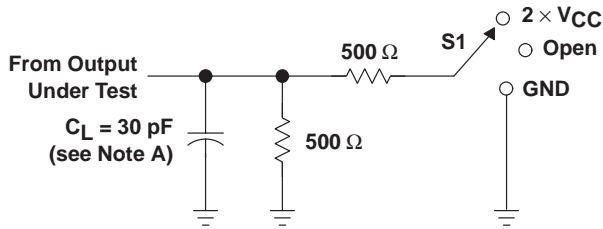
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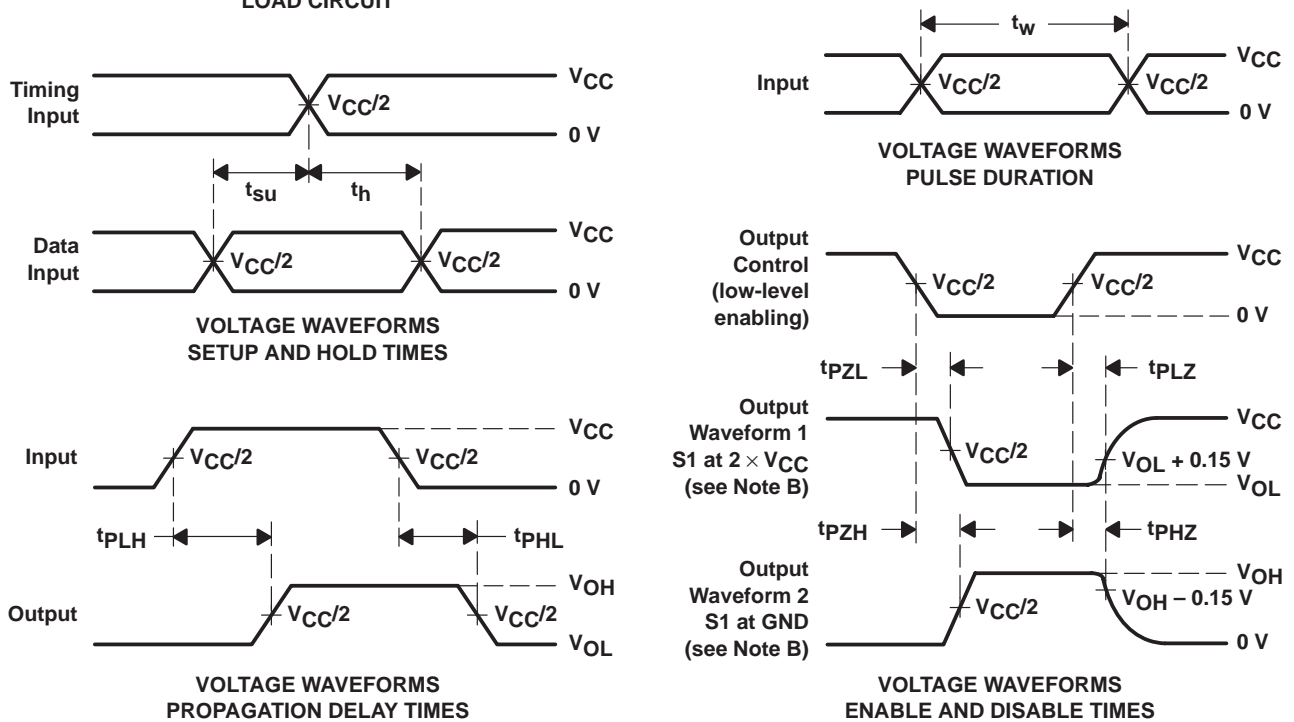
PARAMETER MEASUREMENT INFORMATION

$$V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$$



LOAD CIRCUIT

TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	2 $\times V_{CC}$
t_{PHZ}/t_{PHZ}	GND



- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2 \text{ ns}$, $t_f \leq 2 \text{ ns}$.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 2. Load Circuit and Voltage Waveforms

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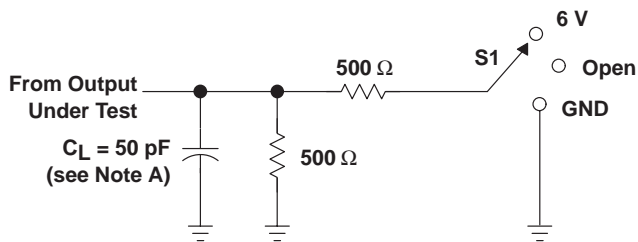
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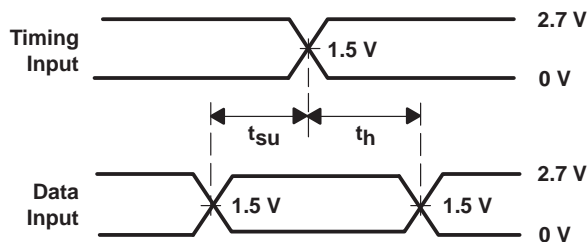
PARAMETER MEASUREMENT INFORMATION

$V_{CC} = 2.7\text{ V AND } 3.3\text{ V} \pm 0.3\text{ V}$

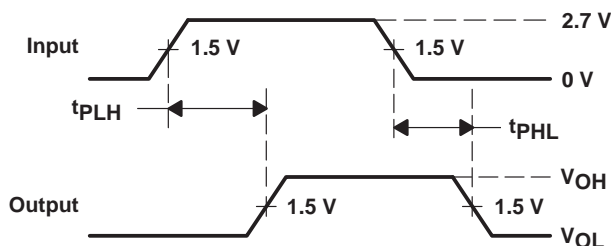


LOAD CIRCUIT

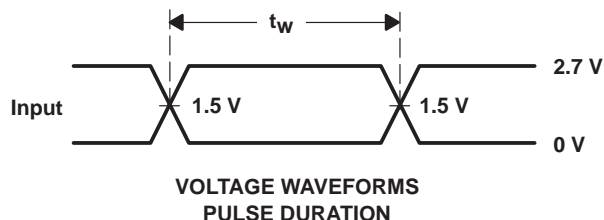
TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	6 V
t_{PHZ}/t_{PZH}	GND



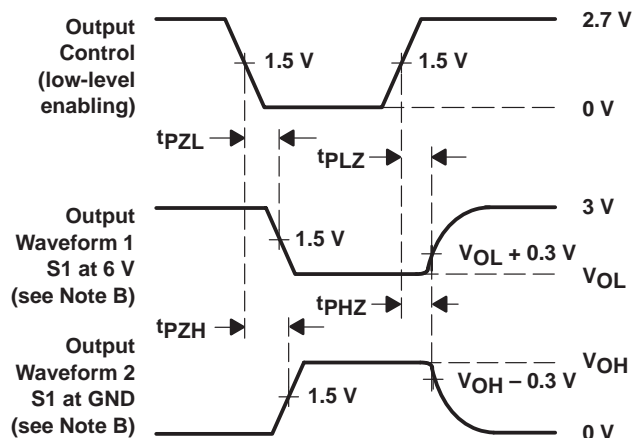
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

- NOTES:
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 - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 2.5\text{ ns}$, $t_f \leq 2.5\text{ ns}$.
 - The outputs are measured one at a time with one transition per measurement.
 - t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - t_{PZL} and t_{PZH} are the same as t_{en} .
 - t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 3. Load Circuit and Voltage Waveforms

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